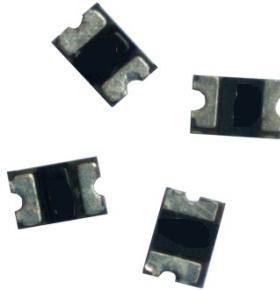


### Description

The 0805 series provides miniature surface mount resettable Over-current protection with holding current from 0.05A to 1.50A. This series is suitable for ultra portable applications where space is at a premium and the device current is low.



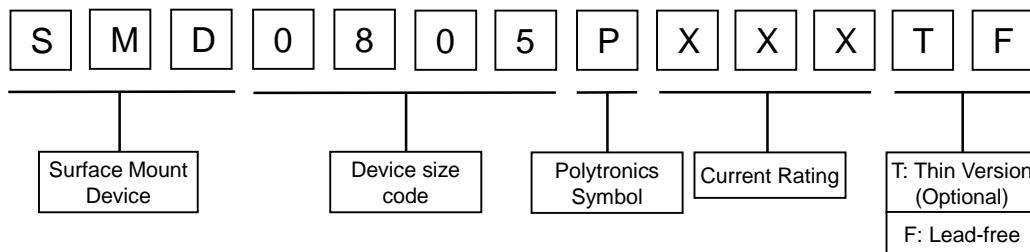
### Features

- | I(hold): 0.05~1.50A
- | Very high voltage surge capabilities
- | Available in lead-free version
- | Fast response to fault current
- | RoHS compliant, Lead-Free and Halogen-Free
- | Low resistance
- | Compact design saves board space
- | Compatible with high temperature solders

### Applications

- | USB peripherals
- | PDAs / digital cameras
- | Disk drives
- | Game console port
- | CD-ROMs
- | protection
- | General electronics
- | Plug and play protection
- | Disk drives
- | for motherboards and
- | Set-top-box and HDMI
- | peripherals
- | Mobile Internet Device
- | Mobile phones - battery
- (MID)
- | and port protection

### Part Number Code



### Environmental Specifications

Test	Conditions	Resistance change
Passive aging	+85 °C, 1000 hrs	±5% typical
Humidity aging	+85°C, 85%R.H., 168 hours	±5% typical
Thermal shock	+85 °C to -40 °C, 20times	±33% typical
Resistance to solvent	MIL-STD-202, Method 215	No change
Vibration	MIL-STD-202, Method 201	No change

Ambient operating conditions : - 40°C to +85°C

Maximum surface temperature of the device in the tripped state is 125 °C



## Performance Specification

Type Number	$I_{hold}$	$I_{trip}$	$V_{max}$	Max. Time to Trip		$I_{max}$	$P_d$ typ	$R_{i_{min}}$	$R_{1_{max}}$
	A	A	V <sub>DC</sub>	Current A	T <sub>max</sub> S	A	W	Ω	Ω
<b>SMD0805P005TF</b>	0.05	0.30	15	0.5	1.50	30	0.5	1.50	20
<b>SMD0805P010TF</b>	0.10	0.30	15	0.5	1.50	30	0.5	0.75	6
<b>SMD0805P020TF</b>	0.20	0.50	9	8	0.02	30	0.5	0.50	3.5
<b>SMD0805P020TF/12</b>	0.20	0.50	12	8	0.02	30	0.5	0.50	3.5
<b>SMD0805P020TF/16</b>	0.20	0.50	16	8	0.02	30	0.5	0.50	3.5
<b>SMD0805P035TF</b>	0.35	0.75	6	8	0.10	30	0.5	0.20	1.2
<b>SMD0805P035TF/12</b>	0.35	0.75	12	8	0.10	30	0.5	0.20	1.2
<b>SMD0805P050TF</b>	0.50	1.00	6	8	0.10	30	0.5	0.10	0.85
<b>SMD0805P050TF/12</b>	0.50	1.00	12	8	0.10	30	0.5	0.10	0.85
<b>SMD0805P050TF/16</b>	0.50	1.00	16	8	0.10	30	0.5	0.10	0.85
<b>SMD0805P050TF/24</b>	0.50	1.00	24	8	0.10	30	0.5	0.10	0.85
<b>SMD0805P075TF</b>	0.75	1.50	6	8	0.20	35	0.6	0.07	0.385
<b>SMD0805P075TF/12</b>	0.75	1.50	12	8	0.20	35	0.6	0.07	0.385
<b>SMD0805P100TF</b>	1.00	1.95	6	8	0.30	35	0.6	0.04	0.23
<b>SMD0805P100TF/12</b>	1.00	1.95	12	8	0.30	35	0.6	0.04	0.23
<b>SMD0805P110TF</b>	1.10	2.20	6	8	0.30	35	0.6	0.035	0.21
<b>SMD0805P110TF/12</b>	1.10	2.20	12	8	0.30	35	0.6	0.035	0.21
<b>SMD0805P125TF</b>	1.25	2.50	6	8	0.60	35	1.5	0.025	0.14
<b>SMD0805P150TF</b>	1.50	3.00	6	8	0.50	35	1.0	0.015	0.13

$V_{max}$  = Maximum operating voltage device can withstand without damage at rated current ( $I_{max}$ ).

$I_{max}$  = Maximum fault current device can withstand without damage at rated voltage ( $V_{max}$ ).

$I_{hold}$  = Hold Current. Maximum current device will not trip in 25°C still air.

$I_{trip}$  = Trip Current. Minimum current at which the device will always trip in 25°C still air.

$P_d$  = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.

$R_{i_{min/max}}$  = Minimum/Maximum device resistance prior to tripping at 25°C.

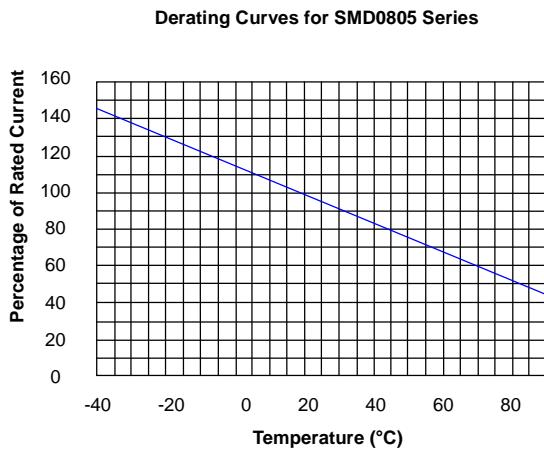
$R_{1_{max}}$  = Maximum device resistance is measured one hour post reflow.



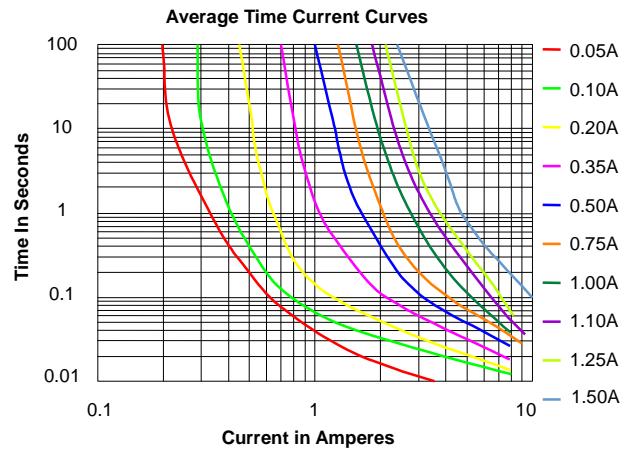
## Thermal Derating Chart-I<sub>h</sub>(A)

Part Number	Ambient Operation Temperature								
	-40 °C	-20 °C	0 °C	25 °C	40 °C	50 °C	60 °C	70 °C	85 °C
SMD0805P005TF	0.07	0.06	0.055	0.05	0.04	0.035	0.03	0.025	0.015
SMD0805P010TF	0.14	0.12	0.11	0.1	0.08	0.07	0.06	0.05	0.03
SMD0805P020TF	0.28	0.25	0.23	0.20	0.17	0.14	0.12	0.10	0.07
SMD0805P020TF/12	0.28	0.25	0.23	0.20	0.17	0.14	0.12	0.10	0.07
SMD0805P020TF/16	0.28	0.25	0.23	0.20	0.17	0.14	0.12	0.10	0.07
SMD0805P035TF	0.47	0.44	0.39	0.35	0.30	0.27	0.24	0.20	0.14
SMD0805P035TF/12	0.47	0.44	0.39	0.35	0.30	0.27	0.24	0.20	0.14
SMD0805P050TF	0.68	0.62	0.55	0.50	0.40	0.37	0.33	0.29	0.23
SMD0805P050TF/12	0.68	0.62	0.55	0.50	0.40	0.37	0.33	0.29	0.23
SMD0805P050TF/16	0.68	0.62	0.55	0.50	0.40	0.37	0.33	0.29	0.23
SMD0805P050TF/24	0.68	0.62	0.55	0.50	0.40	0.37	0.33	0.29	0.23
SMD0805P075TF	1.00	0.90	0.79	0.75	0.63	0.57	0.53	0.41	0.34
SMD0805P075TF/12	1.00	0.90	0.79	0.75	0.63	0.57	0.53	0.41	0.34
SMD0805P100TF	1.35	1.25	1.15	1.00	0.82	0.74	0.65	0.55	0.42
SMD0805P100TF/12	1.35	1.25	1.15	1.00	0.82	0.74	0.65	0.55	0.42
SMD0805P110TF	1.45	1.35	1.20	1.10	0.92	0.84	0.75	0.65	0.52
SMD0805P110TF/12	1.45	1.35	1.20	1.10	0.92	0.84	0.75	0.65	0.52
SMD0805P125TF	1.65	1.53	1.36	1.25	1.05	0.95	0.85	0.74	0.59
SMD0805P150TF	1.98	1.84	1.63	1.50	1.26	1.14	1.02	0.88	0.71

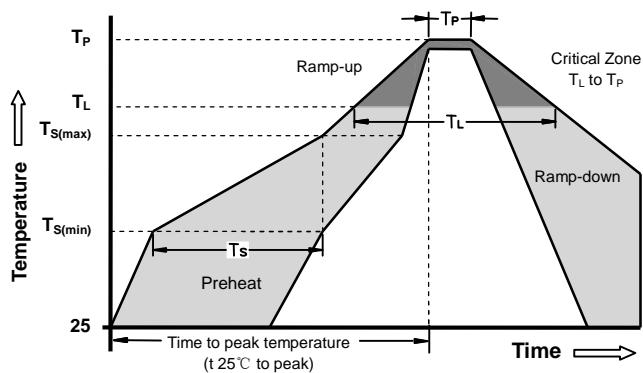
## Thermal Derating Curve



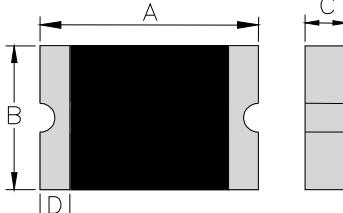
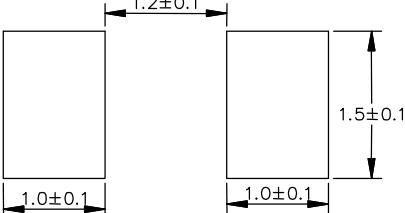
## Average Time-Current Curve



## Soldering Parameters



Reflow Condition		Pb - Free assembly
Pre Heat	-Temperature Min ( $T_{s(min)}$ )	150°C
	-Temperature Max ( $T_{s(max)}$ )	200°C
	- Time (min to max) ( $t_s$ )	60 -180 Seconds
Average ramp up rate ( Liquids Temp $T_L$ ) to peak		3°C/second max
$T_{S(max)}$ to $T_L$ - Ramp-up Rate		3°C/second max
Reflow	- Temperature ( $T_L$ ) (Liquids)	217°C
	- Time (min to max) ( $t_s$ )	60 -150 Seconds
Peak Temperature ( $T_P$ )		260 +0/-5°C
Time within 5°C of actual peak Temperature ( $t_p$ )		20 - 40 Seconds
Ramp-down Rate		6°C/second max
Time $25^{\circ}\text{C}$ to peak Temperature ( $T_P$ )		8 minutes Max
Do not exceed		260°C

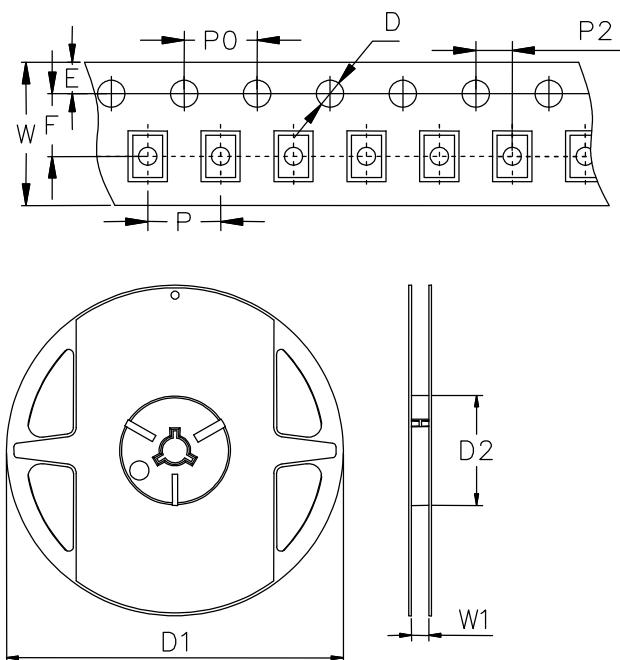
Average Time Current Curves (mm)	Recommended pad layout (mm)
	

## Dimensions

Type Number	Package Dimensions (mm)							Package Dimensions (in)						
	A		B		C		D	A		B		C		D
	min	max	min	max	min	max	min	min	max	min	max	min	max	min
<b>SMD0805P005TF</b>	2	2.2	1.2	1.5	0.4	1.0	0.2	0.079	0.087	0.047	0.059	0.016	0.039	0.008
<b>SMD0805P010TF</b>	2	2.2	1.2	1.5	0.4	1.0	0.2	0.079	0.087	0.047	0.059	0.016	0.039	0.008
<b>SMD0805P020TF</b>	2	2.2	1.2	1.5	0.35	1.0	0.2	0.079	0.087	0.047	0.059	0.014	0.039	0.008
<b>SMD0805P020TF/12</b>	2	2.2	1.2	1.5	0.35	1.0	0.2	0.079	0.087	0.047	0.059	0.014	0.039	0.008
<b>SMD0805P020TF/16</b>	2	2.2	1.2	1.5	0.35	1.0	0.2	0.079	0.087	0.047	0.059	0.014	0.039	0.008
<b>SMD0805P035TF</b>	2	2.2	1.2	1.5	0.35	1.0	0.2	0.079	0.087	0.047	0.059	0.014	0.039	0.008
<b>SMD0805P035TF/12</b>	2	2.2	1.2	1.5	0.35	1.0	0.2	0.079	0.087	0.047	0.059	0.014	0.039	0.008
<b>SMD0805P050TF</b>	2	2.2	1.2	1.5	0.30	1.1	0.2	0.079	0.087	0.047	0.059	0.012	0.043	0.008
<b>SMD0805P050TF/12</b>	2	2.2	1.2	1.5	0.30	1.1	0.2	0.079	0.087	0.047	0.059	0.012	0.043	0.008
<b>SMD0805P050TF/16</b>	2	2.2	1.2	1.5	0.5	1.1	0.2	0.079	0.087	0.047	0.059	0.02	0.043	0.008
<b>SMD0805P050TF/24</b>	2	2.2	1.2	1.5	0.5	1.1	0.2	0.079	0.087	0.047	0.059	0.02	0.043	0.008
<b>SMD0805P075TF</b>	2	2.2	1.2	1.5	0.4	1.3	0.2	0.079	0.087	0.047	0.059	0.016	0.051	0.008
<b>SMD0805P075TF/12</b>	2	2.2	1.2	1.5	0.4	1.3	0.2	0.079	0.087	0.047	0.059	0.016	0.051	0.008
<b>SMD0805P100TF</b>	2	2.2	1.2	1.5	0.5	1.3	0.2	0.079	0.087	0.047	0.059	0.02	0.051	0.008
<b>SMD0805P100TF/12</b>	2	2.2	1.2	1.5	0.5	1.3	0.2	0.079	0.087	0.047	0.059	0.02	0.051	0.008
<b>SMD0805P110TF</b>	2	2.2	1.2	1.5	0.5	1.3	0.2	0.079	0.087	0.047	0.059	0.02	0.051	0.008
<b>SMD0805P110TF/12</b>	2	2.2	1.2	1.5	0.5	1.3	0.2	0.079	0.087	0.047	0.059	0.02	0.051	0.008
<b>SMD0805P125TF</b>	2	2.2	1.2	1.5	1.0	1.5	0.2	0.079	0.087	0.047	0.059	0.039	0.059	0.008
<b>SMD0805P150TF</b>	2	2.2	1.2	1.5	1.0	1.5	0.2	0.079	0.087	0.047	0.059	0.039	0.059	0.008



## Taping and Reel Specifications



Symbol	Millimeters	Inches
W	8±0.3	0.315±0.012
P	4±0.1	0.157±0.004
P0	4±0.1	0.157±0.004
P2	2±0.05	0.079±0.002
F	3.5±0.05	0.138±0.002
E	1.75±0.1	0.069±0.004
D	1.55±0.05	0.061±0.002
D1(max)	178	7.007
D2(min)	60	2.362
W1	9.0±0.5	0.354±0.02

Model	Quantity
SMD0805P005TF~ SMD0805P050TF/24	5000PCS
SMD0805P050TF/12,075TF,075TF/12	4000PCS
SMD0805P100TF~ SMD0805P150TF	3500PCS

单击下面可查看定价，库存，交付和生命周期等信息

[\*\*>>SUNMATE\(森美特\)\*\*](#)